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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Michael Bauer et al.

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(International Application No. PCT/DE2005/000892)

Filed: Herewith
(Priority Date 19 May 2004)
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Docket No.: I431.145.101/FIN 606 PCT

Title: SUPPORT WITH SOLDER BALL ELEMENTS AND A METHOD FOR
POPULATING SUBSTRATES WITH SOLDER BALLS

PRELIMINARY AMENDMENT

Mail Stop PCT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

This Preliminary Amendment amends the Utility Patent Application filed herewith and should be used to calculate filing fees due. Prior to examination of the above-identified patent application, please amend as follows: